

Docket No.: P2001,0128

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : HEIKO HOMMEN ET AL.  
Filed : CONCURRENTLY HEREWITH  
Title : METHOD FOR EXPOSING AT LEAST ONE OR AT LEAST TWO  
SEMICONDUCTOR WAFERS

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In accordance with 37 C.F.R. 1.98 copies of the following patents and/or publications are submitted herewith:

U.S. Patent No. 5,877,861 (Ausschnitt et al.), dated March 2, 1999;

US Patent No. 5,863,680 (Kawakubo et al.), dated January 26, 1999;

US Patent No. 5,798,530 (Okumura), dated August 25, 1998;

European Patent Application EP 0 044 450 A1 (Hart), dated January 27, 1982.

Respectfully submitted,

  
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For Applicants

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**REG. NO. 29,308**

Date: August 6, 2003

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<b>FORM PTO-1449 (SUBSTITUTE)</b>  U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  <b>INFORMATION DISCLOSURE          STATEMENT BY APPLICANT</b> (37 CFR 1.98(b))				Attorney Docket No.: P2001,0128 Appl. No.: _____  Applicant: HEIKO HOMMEN ET AL.  Filing Date: August 6, 2003 Group Art Unit: _____			
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EXAMINER INITIALS	PATENT NO.	DATE	PATENTEE	CLASS	SUB CLASS	FILING DATE
	A	5,877,861	3/2/99	Ausschnitt et al.		
	B	5,863,680	1/26/99	Kawakubo et al.		
	C	5,798,530	8/25/98	Okumura		
	D					
	E					
	F					
	G					
	H					
	I					

  

FOREIGN PATENT DOCUMENT							
DOCUMENT NO.	DATE	COUNTRY	CLASS	SUB CLASS	TRANSL. YES   NO		
	J	0 044 450 A1	1/27/82	Europe			
	K						
	L						
	M						
	N						

  

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)		

EXAMINER	DATE CONSIDERED
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EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.